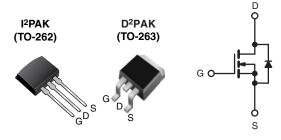


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	800					
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	3.0				
Q _g (Max.) (nC)	78					
Q _{gs} (nC)	9.6					
Q _{gd} (nC)	45					
Configuration	Single					



N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

ORDERING INFORMATION							
Package	D ² PAK (TO-263)	D ² PAK (TO-263)	I ² PAK (TO-262)				
Lead (Pb)-free and Halogen-free	SiHFBE30S-GE3	SiHFBE30STRL-GE3ª	SiHFBE30L-GE3				
Lood (Bb) free	IRFBE30SPbF	IRFBE30STRLPbF ^a	IRFBE30LPbF				
Lead (Pb)-free	SiHFBE30S-E3	SiHFBE30STL-E3ª	SiHFBE30L-E3				
Note	*	·	<u>.</u>				

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	800	V	
Gate-Source Voltage			V _{GS}	± 20	v	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	1	4.1		
Continuous Drain Current	V _{GS} at 10 V	T _C = 100 °C	I _D	2.6	А	
Pulsed Drain Current ^a			I _{DM}	16		
Linear Derating Factor		1.0	W/°C			
Single Pulse Avalanche Energy ^b			E _{AS}	260	mJ	
Avalanche Current ^a			I _{AR}	4.1	А	
Repetitive Avalanche Energy ^a			E _{AR}	13	mJ	
Maximum Power Dissipation	T _C =	25 °C	PD	125	W	
Peak Diode Recovery dV/dt ^c			dV/dt	2.0	V/ns	
Operating Junction and Storage Temperature Rang	T _J , T _{stg}	- 55 to + 150	- °C			
Soldering Recommendations (Peak Temperature) for 10 s				300 ^d	C	
Mounting Torque	6.20 or 1	0.00		10	lbf ∙ in	
Mounting Torque	6-32 or M3 screw			1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 29 mH, $R_g = 25 \Omega$, $I_{AS} = 4.1$ A (see fig. 12). c. $I_{SD} \le 4.1$ A, dI/dt ≤ 100 A/µs, $V_{DD} \le 600$ V, $T_J \le 150$ °C. d. 1.6 mm from case.

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RoHS³ COMPLIANT

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	-	62			
Case-to-Sink, Flat, Greased Surface	R _{thCS}	-	0.50	-	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	1.0			

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		·					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	800	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D = 1 mA	-	0.90	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zara Cata Valtaga Drain Current	1	V _{DS} =	= 800 V, V _{GS} = 0 V	-	-	100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 640 V	/, V _{GS} = 0 V, T _J = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2.5 A ^b	-	-	3.0	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	= 100 V, I _D = 2.5 A	2.5	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	1300	-	
Output Capacitance	C _{oss}	1	$V_{DS} = 25 V,$	-	310	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	190	-	
Total Gate Charge	Qg		$V_{GS} = 10 \text{ V}$ $I_D = 4.1 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13 ^b		-	78	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$			-	9.6	nC
Gate-Drain Charge	Q _{gd}			-	-	45	
Turn-On Delay Time	t _{d(on)}		·	-	12	-	
Rise Time	t _r	- V _{DD} =	V _{DD} = 400 V, I _D = 4.1 A,		33	-	- ns
Turn-Off Delay Time	t _{d(off)}	$R_g = 12 \Omega$, $R_D = 95 \Omega$, see fig. 10^{b}		-	82	-	
Fall Time	t _f	1		-	30	-	1
Internal Drain Inductance	L _D	Between lead 6 mm (0.25")	from	-	4.5	-	
Internal Source Inductance	L _S	package and die contact	center of	-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	showing the	MOSFET symbol showing the		-	4.1	A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	16	
Body Diode Voltage	V_{SD}	T _J = 25 °C	$V_{\rm s}$, I _S = 4.1 A, V _{GS} = 0 V ^b	-	-	1.8	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 °C I	= 4.1 A, dl/dt = 100 A/µs ^b	-	480	720	ns
Body Diode Reverse Recovery Charge	Q _{rr}	1J=20 0, IF	$= 4.1 \text{ A}, \text{ al/al} = 100 \text{ A/} \mu \text{S}^{0}$	-	1.8	2.7	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)					L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

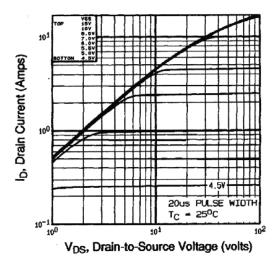


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

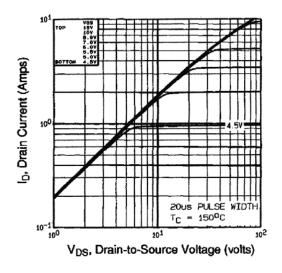


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

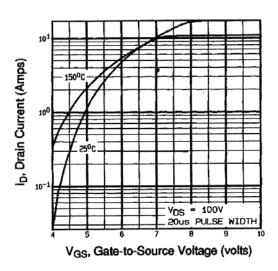


Fig. 3 - Typical Transfer Characteristics

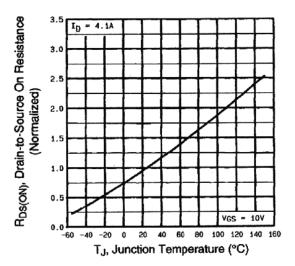


Fig. 4 - Normalized On-Resistance vs. Temperature

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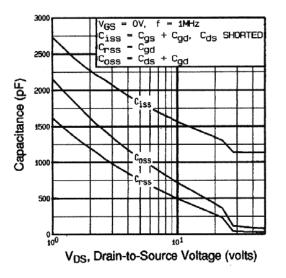


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

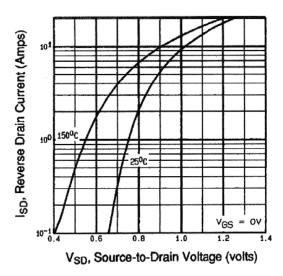


Fig. 7 - Typical Source-Drain Diode Forward Voltage

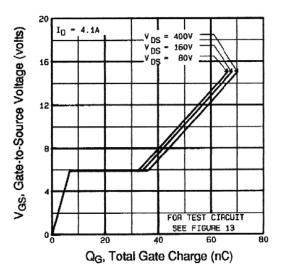


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

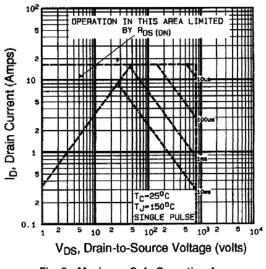


Fig. 8 - Maximum Safe Operating Area

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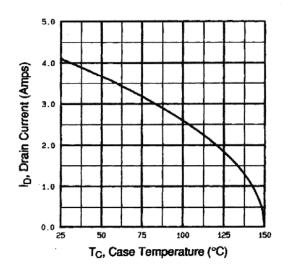


Fig. 9 - Maximum Drain Current vs. Case Temperature

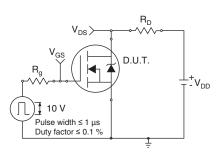


Fig. 10a - Switching Time Test Circuit

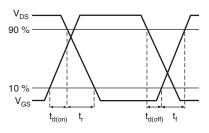
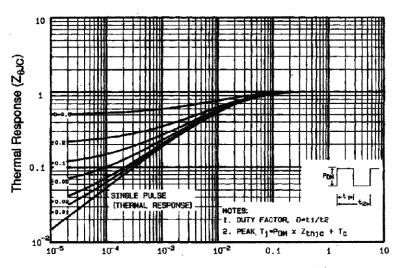
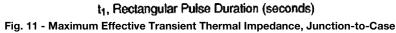


Fig. 10b - Switching Time Waveforms





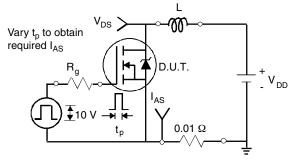


Fig. 12a - Unclamped Inductive Test Circuit

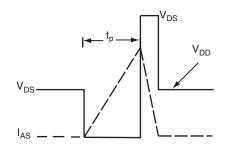


Fig. 12b - Unclamped Inductive Waveforms

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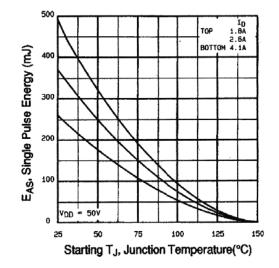


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

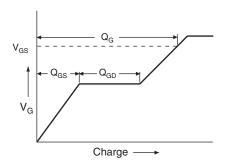


Fig. 13a - Maximum Avalanche Energy vs. Drain Current

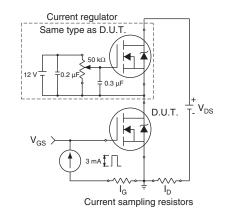
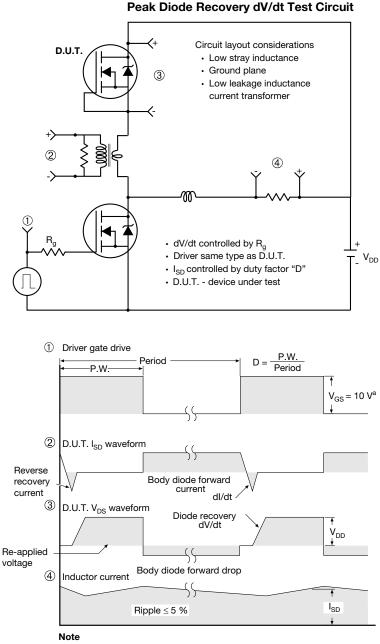


Fig. 13b - Gate Charge Test Circuit

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a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg291119.

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TO-263AB (HIGH VOLTAGE)

<u>′3</u>`

 $\overline{4}$

-A

(Datum A)

/4\L1

			2 x b2 2 x b	Detail A	2)		Rot		Seatin A1	ng plane
	MILLIMETERS INCHES				MILLIMETERS		INC	ICHES		
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
A1	0.00	0.25	0.000	0.010		Е	9.65	10.67	0.380	0.420
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b1	0.51	0.89	0.020	0.035		е	2.54	BSC	0.100) BSC
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	0.575	0.625
b3	1.14	1.73	0.045	0.068		L	1.78	2.79	0.070	0.110
с	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066
c1	0.38	0.58	0.015	0.023		L2	-	1.78	-	0.070
c2	1.14	1.65	0.045	0.065		L3	0.25	BSC	0.010) BSC
D	8.38	9.65	0.330	0.380		L4	4.78	5.28	0.188	0.208
		15 Can 00								

A

Gauge plane

0° to 8°

ECN: S-82110-Rev. A, 15-Sep-08 DWG: 5970

Notes

2. Dimensions are shown in millimeters (inches).

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.



Package Information

B

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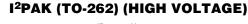
^{1.} Dimensioning and tolerancing per ASME Y14.5M-1994.

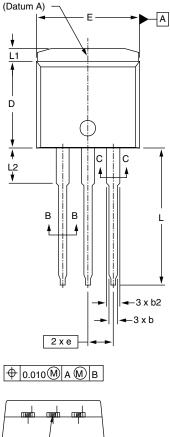
^{3.} Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

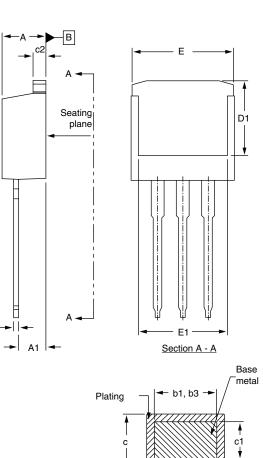


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Lead tip

MILLIMETERS

MAX.

4.83

3.02

0.99

0.89

1.78

1.73

0.74

0.58

1.65

MIN.

4.06

2.03

0.51

0.51

1.14

1.14

0.38

0.38

1.14



INCHES

MIN.

0.160

0.080

0.020

0.020

0.045

0.045

0.015

0.015

0.045

С

Section B - B and C -	С
Scale: None	

-

— (b, b2) —

ES		MILLIN	IETERS	INC	HES
MAX.	DIM.	MIN.	MAX.	MIN.	MAX.
0.190	D	8.38	9.65	0.330	0.380
0.119	D1	6.86	-	0.270	-
0.039	E	9.65	10.67	0.380	0.420
0.035	E1	6.22	-	0.245	-
0.070	е	2.54	2.54 BSC		BSC
0.068	L	13.46	14.10	0.530	0.555
0.029	L1	-	1.65	-	0.065
0.023	L2	3.56	3.71	0.140	0.146
0.065					

ECN: S-82	442-Rev. A,	27-Oct-08
DWG: 597	7	

Notes

DIM.

А

A1

b

b1

b2

b3

с c1

c2

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outmost extremes of the plastic body.
- 3. Thermal pad contour optional within dimension E, L1, D1, and E1.
- 4. Dimension b1 and c1 apply to base metal only.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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